

# AB005S-E THRU AB10S-E

## SINGLE PHASE GLASS PASSIVATED BRIDGE RECTIFIER

VOLTAGE: 50V to 1000V

CURRENT: 0.8A

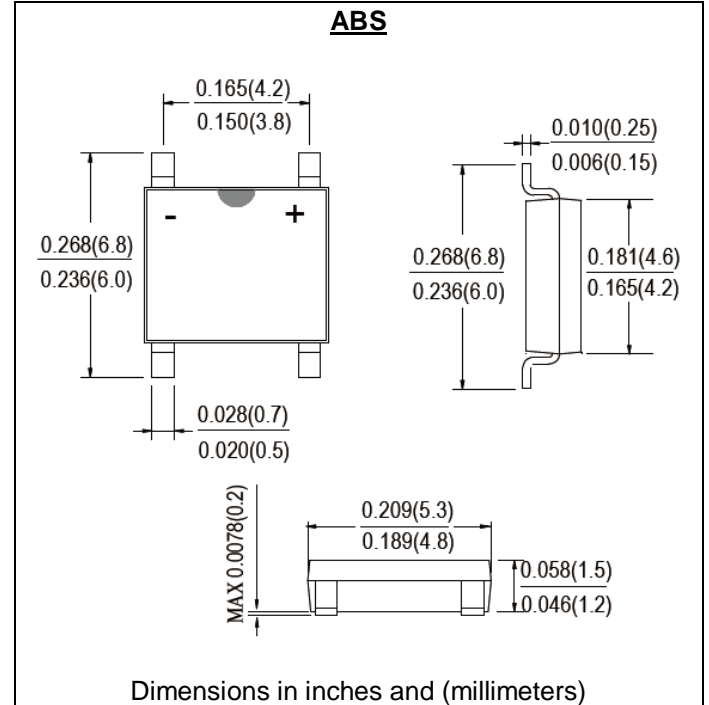


### FEATURE

Ideal for printed circuit board  
Glass passivated chip  
Reliable low cost construction utilizing molded plastic technique  
Small size, simple installation  
High temperature soldering guaranteed: 260°C/10 seconds  
Halogen Free

### MECHANICAL DATA

Terminal: Plated leads solderable per J-STD-002  
Case: UL-94 Class V-0 recognized Halogen Free Epoxy  
Polarity: Polarity symbol marked on body



## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half -wave, 60Hz, resistive or inductive load rating at 25°C, unless otherwise stated)

	Symbol	AB00 5S-E	AB01 S-E	AB02 S-E	AB04 S-E	AB06 S-E	AB08 S-E	AB10 S-E	Units
Maximum Recurrent Peak Reverse Voltage	V <sub>rrm</sub>	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V <sub>rms</sub>	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (Note 1)	I <sub>f(av)</sub>				0.5				A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I <sub>fsm</sub>				30				A
Rating for fusing (t<8.3ms)	I <sup>2</sup> t				3.74				A <sup>2</sup> sec
Maximum Instantaneous Forward Voltage @IF=0.5A @IF=0.8A	V <sub>f</sub>				0.95 1.0				V
Maximum DC Reverse Current at rated DC blocking voltage Ta =25°C Ta =125°C	I <sub>r</sub>				5.0 200				μA
Typical Thermal resistance per leg	R <sub>th(jl)</sub> R <sub>th(ja)</sub>				25 62.5				°C/W
Storage and Operating Junction Temperature Range	T <sub>stg, Tj</sub>				-55 to +150				°C

Note:

1. Mounted on glass epoxy PC board with 1.3mm<sup>2</sup> solder pad

## RATINGS AND CHARACTERISTIC CURVES AB005S-E THRU AB10S-E

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

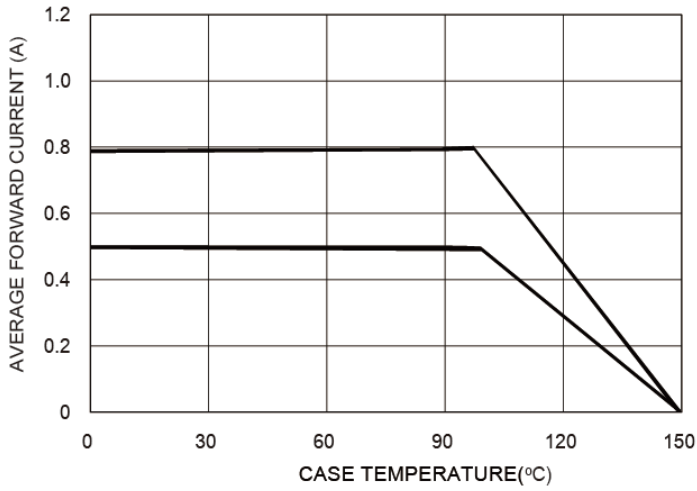


FIG. 2 TYPICAL FORWARD CHARACTERISTIC

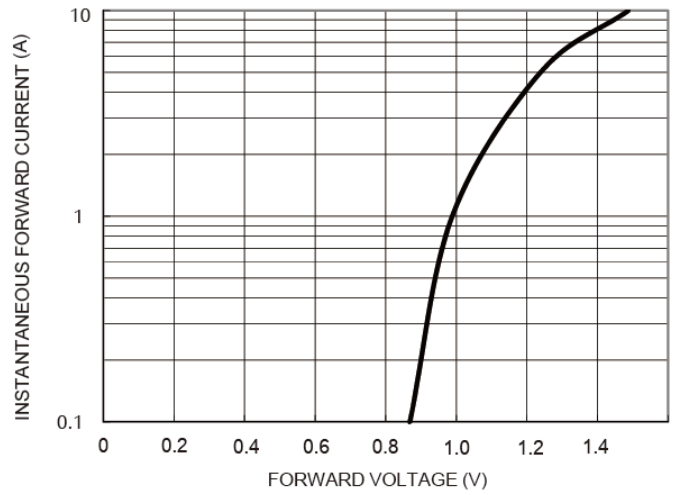


FIG.3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

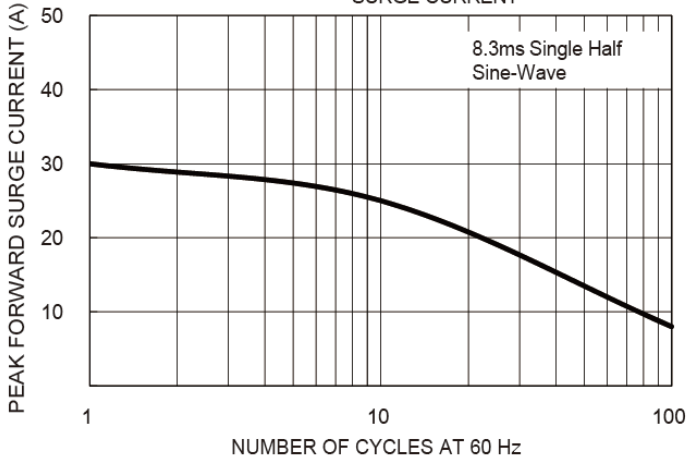


FIG. 4 TYPICAL REVERSE CHARACTERISTICS

